



RXi2-XP Industrial PC

The Next Generation of Ruggedized Computing



GE's Automation & Controls has developed the next generation of its powerful, expandable, and reliable industrial computers (IPC). RXi2 IPCs offer new processor choices, increased and faster storage, improved graphics, and enhanced security features.

The RXi2-XP IPC delivers compact, rugged, mid-to high-range performance computing capabilities to run HMI, historian, and analytics applications right at the machine to enable improved real-time control of operations and better integration into plant-wide systems.

Combining outstanding computing capabilities with the added expandability of 0, 1, 2 or 4 PCI Express slots and CFast storage, the RXi2-XP is ideal for a range of demanding industrial applications.

High-Performance Computing

GE selected the latest Intel processors based on their unmatched performance. The RXi2-XP IPC has up to 32GB of ECC RAM, 5 Gigabit Ethernet interfaces, and industrial grade high-speed HDD storage (or optional SSD disk storage) to complete the high-performance design.

These features make the RXi2-XP IPC the perfect platform for running GE's Proficy* software applications or other industrial applications right at the machine, even in the harshest environments.

The RXi2-XP IPC provides additional application flexibility with both mini PCI Express and low-profile PCI Express slots. This expandability combined with advanced CPUs delivers high-performance, computing.

To help keep data and operations secure, the RXi2-XP utilizes Trusted Platform Module (TPM) and Microsoft Secure Boot technology.

Greater Uptime

All aspects of the RXi2-XP IPC have been engineered for reliability in harsh environments, from the use of all industrial grade components to its fanless design. The core of the RXi2-XP IPC architecture is GE's rugged COM Express modular CPU platform. GE incorporates patented thermal monitoring technology with sophisticated passive cooling techniques to provide the highest-performance, fanless industrial computing platform that can operate in extended temperature ranges.

Enhanced Productivity & Lower TCO

The RXi2-XP IPC combines high performance with reliability, enhancing productivity and reducing cost of ownership.

The RXi2-XP IPC delivers low TCO through features such as compact size, reduced maintenance, low power consumption, and ease of future performance upgrades enabled by our innovative rugged COM Express CPU architecture.

| FEATURE | BENEFIT |
|---|--|
| 6th Generation Intel® Core™ i3, i5, i7 and Xeon® CPUs | <ul style="list-style-type: none"> Delivers high-performance computing for applications that load, manipulate and store large amounts of data, or handle multiple communication ports in real-time |
| Fanless operation | <ul style="list-style-type: none"> A robust, reliable solution with no moving parts and minimized dust contamination |
| 5 Gigabit Ethernet ports (four with Time SYNC IEEE1588 and 802.1AS) | <ul style="list-style-type: none"> Network implementation flexibility Multiple high-speed Ethernet links for communication-centric applications with support for deterministic transfer of data/commands |
| 0, 1, 2 or 4 PCIe Expansion slots | <ul style="list-style-type: none"> Add new functionality on demand to support specific application needs |

Specifications

Processor

- Intel® core™ i3-6102E Processor, 25W 2c 1.9GHz 3MB cache
- Intel® core™ i5-6440EQ Processor, 45W 4c 2.7GHz (-3.4GHz) 6MB no ECC
- Intel® core™ i7-6820EQ Processor, 45W 4c 2.8GHz (-3.5GHz) 8MB no ECC
- Intel® XEON® Processor E3-1505L v5, 25W 4c 2.0GHz (-2.8GHz) 8MB
- Intel® XEON® Processor E3-1505M v5, 45/35W 4c 2.8GHz (-3.7GHz) 8MB

Memory

- Up to 32GB DDR4-2133
- Soldered, with ECC

Storage Interfaces

- Primary storage device – M.2 PCI Express Gen3 x4 or M.2 SATA Gen3
- Secondary storage option – Twin 2.5" SATA drive bays, hot swap and RAID enabled
- CFAST slot, user accessible, supports boot, hot plug

Ethernet

- Four 1-gigabit Ethernet channels – RJ-45 standard, SFP optional
- One 1-gigabit Ethernet channel w/ remote management capability – RJ45

Wireless Communication

- LTE modem option using Mini-PCIE with UIM card holder
- Wifi/Bluetooth radio option using M.2 expansion slot

Video/Graphics Interface

- Twin DisplayPort++ 1.2 for a total of 3 independent displays

USB Interface

- Four USB 3.0 external
- Two USB 2.0 internal

Serial Communications

- 2 to 4 channels
- Two RS232, two RS422/485

Expansion

- Mini-PCIE card site for NvSRAM card, LTE modem, or other
- M.2 communications slot for WiFi and Bluetooth
- PCI Express expansion slots:
 - Zero
 - One Gen3 x4
 - Two Gen2 x4
 - Four 1 Gen2 x4, 3 Gen2 x1

Non-Volatile Memory

- 512 KB, 1MB or 2MB NvSRAM
- Storage for process relevant data
- NvSRAM option uses mini-PCIE slot

LED

- Power, TPM, Temperature, SATA
- Ethernet Link/Activity
- One User Defined LED

Others

- Timers – Legacy PC-AT, HPET
- Twin Watchdog Timers (OS, application)
- Thermal monitoring
- RTC with Lithium coin cell battery

Power

- Input – 24V DC (±25%) with protection

Environmental

All values under typical conditions without added expansion slot cards.

Extended temperature variants are available upon request.

The maximum extended temperature ranges mentioned in the table below are achievable with a specific choice of CPU and storage, and without extension cards installed in the system.

For detailed information please read the manual.

| Range | Operating | Storage |
|----------|-----------------------------|----------------|
| Standard | 0°C to +60°C ¹ | -40°C to +85°C |
| Extended | -40°C to +70°C ² | -40°C to +85°C |

¹ At 100% CPU load temperature range requires vertical orientation of the heat sink fins at free convection.

² Operating temperature is dependent on the CPU and SSD choice, application software, orientation of the heat sink fins at free convection. For detailed recommendations please contact support team.

| | Operating | Storage |
|----------|--------------------|-------------------|
| Humidity | 5-95% @ +40°C | 5-95% @ +40°C |
| Altitude | 6,600 ft. (2.0 km) | 40000 ft. (12 km) |

BIOS

- UEFI AMI Aptio® 5

Dimensions (H x W x D)

- 0 slot
 - 252 x 203 x 108.5 mm (9.92 x 8 x 4.24 in)
 - Weight – 4,2kg
- 1 slot
 - 252 x 203 x 132 mm (9.92 x 8 x 4.24 in)
 - Weight – 4,3kg
- 2 slot
 - 252 x 203 x 155.5 mm (9.92 x 8 x 6.13 in)
 - Weight – 4,4kg
- 4 slot
 - 252 x 203 x 108.5 mm (9.92 x 8 x 4.24 in)
 - Weight – 4,6kg

Mechanical

- Rugged aluminum and stainless steel housing for optimal thermal management and durability
- IP20 – Protection against particles
- Flat and Slim (Book) mounting orientation options

Software Support

- Microsoft® Windows® 10 Professional 64-Bit
- Linux® Kernel 4.4
- VXWorks® 7.0

Safety

- Designed to meet standard UL1950, CE class A, FCC-A
- Designed to meet marine class A

Ordering Information

| PART NUMBER | DESCRIPTION | OPERATING TEMPERATURE |
|----------------------|---|-----------------------|
| R2X0N1R0B1TOA | Quad Core i7-6820EQ, 2.8GHz, 0 Slot, 256GB SSD, 16GB DDR4, 2xRS232, 5xRJ45, No OS | 0°C to +60°C |
| R2X0N1R1B1TOA | Quad Core i7-6820EQ, 2.8GHz, 0 Slot, 256GB SSD, 16GB DDR4, 2xRS232, 5xRJ45, Windows 10 | 0°C to +60°C |
| R2X1N1B0A1TOA | Dual Core i3-6102E, 1.9GHz, 1 Slot, 128GB SSD, 8GB DDR4 ECC, 2xRS232, 5xRJ45, No OS | 0°C to +60°C |
| R2X1N1B1A1TOA | Dual Core i3-6102E, 1.9Hz, 1 Slot, 128GB SSD, 8GB DDR4 ECC, 2xRS232, 5xRJ45, Windows 10 | 0°C to +60°C |
| R2X1N1C0A1TOA | Quad Core XEON E3-1505Lv5, 2.0GHz, 1 Slot, 128GB SSD, 32GB DDR4 ECC, 2xRS232, 5xRJ45, No OS | 0°C to +60°C |
| R2X1N1C1A1TOA | Quad Core XEON E3-1505Lv5, 2.0GHz, 1 Slot, 128GB SSD, 32GB DDR4 ECC, 2xRS232, 5xRJ45, Windows 10 | 0°C to +60°C |
| R2X2N1C0B2TOF | Quad Core XEON E3-1505Lv5, 2.0GHz, 2 Slot, 256GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, No OS | -40°C to +70°C |
| R2X4N1B0A2TOA | Dual Core i3-6102E, 1.9GHz, 4 Slot, 128GB SSD, 8GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, No OS | 0°C to +60°C |
| R2X4N1B1A2TOA | Dual Core i3-6102E, 1.9GHz, 4 Slot, 128GB SSD, 8GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10 | 0°C to +60°C |
| R2X4N1C0A2TOA | Quad Core XEON E3-1505Lv5, 2.0GHz, 4 Slot, 128GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, No OS | 0°C to +60°C |
| R2X4N1C1A2TOA | Quad Core XEON E3-1505Lv5, 2.0GHz, 4 Slot, 128GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10 | 0°C to +60°C |
| R2X4N1D0C2TOA | Quad Core XEON E3-1505M, 2.8GHz, 4 Slot, 512GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, No OS | 0°C to +60°C |
| R2X4N1D1C2TOA | Quad Core XEON E3-1505M, 2.8GHz, 4 Slot, 512GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10 | 0°C to +60°C |

GE Power

Automation & Controls

2500 Austin Dr

Charlottesville, VA 22911

1-800-433-2682 or 1-434-978-5100

www.geautomation.com